

SPECIFICATION:

Current rating: 1.5 A
 Insulation resistance: 500 MΩ min.
 Contact resistance: 40 mΩ max.
 Dielectric voltage: 1000 V AC
 Operation temperature: 0 °C to +70 °C

MATERIAL:

Housing: PBT UL94V-0
 Contacts: Phosphorbronze
 Solder pins: Phosphorbronze

FINISH:

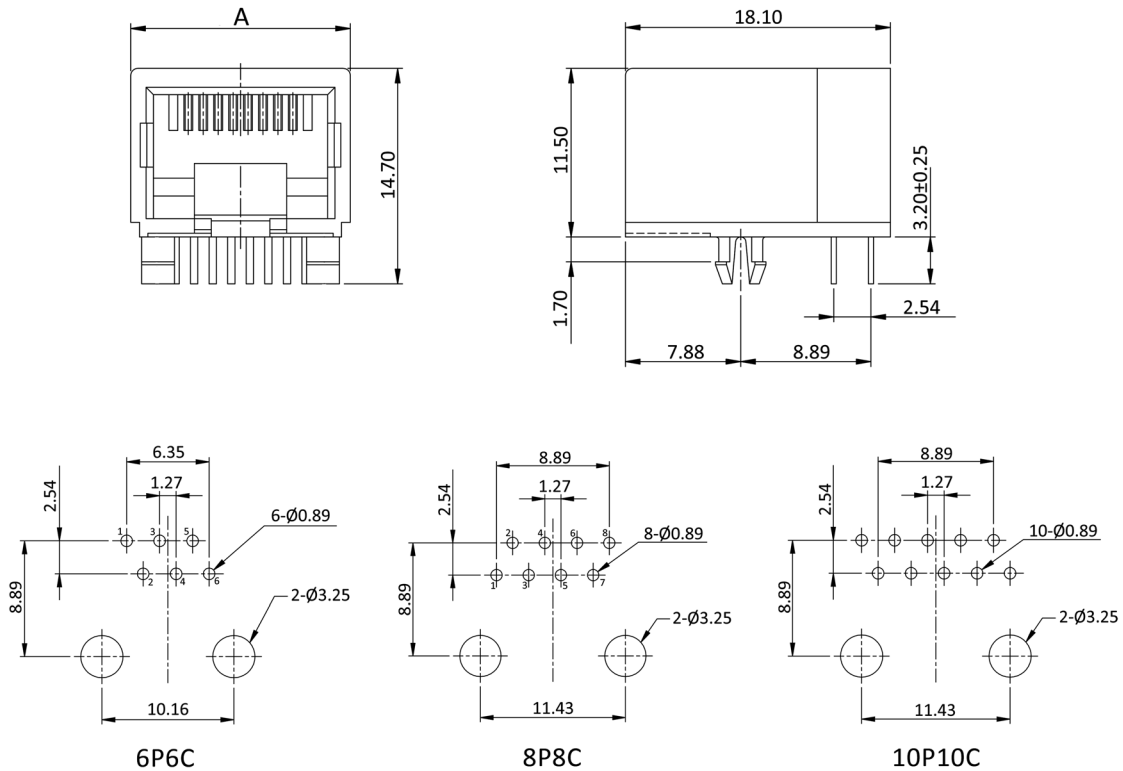
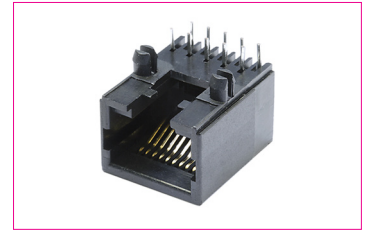
Contacts: Gold over nickel
 Solder pins: Tin over nickel

HANDLING:

Processing: Wave soldering
 Packing: Tray

TOLERANCE:

.X ± 0.38
 .XX ± 0.25



Dimensions

Positions:	A
6	12.96
8	15.00
10	15.00

Order-Information

Identifier:	Positions:	Conductors:	Contact Plating:
MEB	# /	# PL	#
Modular Jack low profile, unshielded, PCB mount	6: 6P 8: 8P 10: 10P	6: 6C 8: 8C 10: 10C	empty: 6 μ" Gold * B: 15 μ" Gold C: 30 μ" Gold D: 50 μ" Gold

* = standard